

IP4791CZ12

HDMI ESD protection, level shifter and backdrive protection

Rev. 3 — 7 January 2011

Product data sheet

1. General description

The IP4791CZ12 is designed to protect mobile High-Definition Multimedia Interface (HDMI) transmitter interfaces. It includes level shifting for the Data Display Channel (DDC), Consumer Electronic Control (CEC), hot plug signal and backdrive protection. In addition, all signals are protected by high-level ElectroStatic Discharge (ESD) protection diodes.

The level shifting function is required to protect the I/Os against overvoltages when the transmitter operates at a supply voltage lower than the external devices. The IP4791CZ12 contains active buffers to provide the level shifting function, hot plug detect input and the CEC pull-up current source.

The ESD protection diodes provide protection from ESD voltages up to ± 8 kV, according to IEC 61000-4-2, level 4.

2. Features and benefits

- HDMI 1.3 compliant
- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- Robust ESD protection without degradation after multiple ESD strikes
- Low leakage even after several hundred ESD discharges
- Bidirectional level shifting buffer provided for DDC clock and data channels
- Backdrive protection
- Power management
- CEC pull-up current source and level shifting buffer
- Hot plug detect module with pull-down resistor
- Matched 0.4 mm trace spacing for HDMI type C connector

3. Applications

The IP4791CZ12 can be used with a range of HDMI transmitter devices including:

- Personal computer
- Notebook
- Mobile phone
- DV camcorder
- Digital still camera
- MP3 player



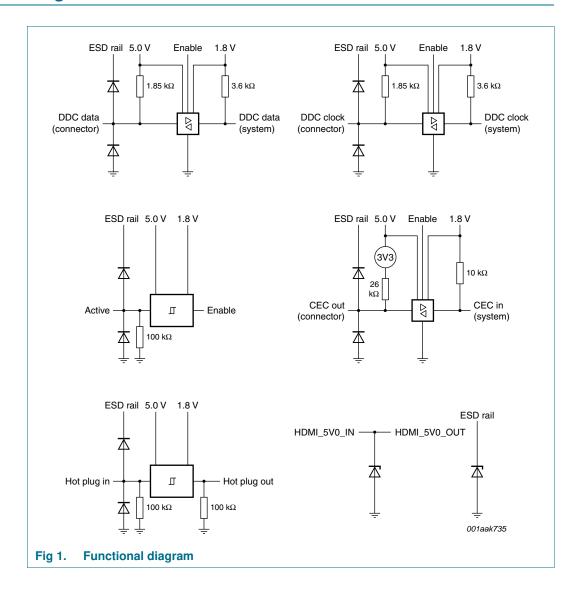
HDMI ESD protection, level shifter and backdrive protection

4. Ordering information

Table 1. Ordering information

| Type number | umber Package | | | | | | |
|-------------|---------------|---|-----------|--|--|--|--|
| | Name | Description | Version | | | | |
| IP4791CZ12 | HXSON12 | plastic, thermal enhanced extremely thin small outline package; no leads; 12 terminals; body $2.1\times2.5\times0.5$ mm | SOT1156-1 | | | | |

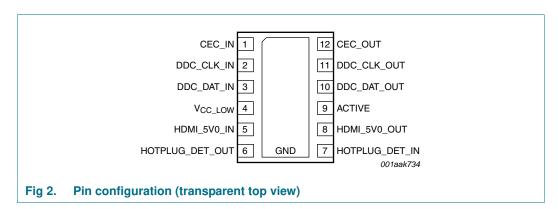
5. Functional diagram



HDMI ESD protection, level shifter and backdrive protection

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|---------------------|-----|---|
| CEC_IN | 1 | CEC system side |
| DDC_CLK_IN | 2 | DDC clock system side |
| DDC_DAT_IN | 3 | DDC data system side |
| V _{CC_LOW} | 4 | supply voltage, low voltage side for level shifting |
| HDMI_5V0_IN | 5 | 5 V line from main supply |
| HOTPLUG_DET_OUT | 6 | hot plug detect system side |
| HOTPLUG_DET_IN | 7 | hot plug detect connector side |
| HDMI_5V0_OUT | 8 | 5 V line to HDMI connector |
| ACTIVE | 9 | power saving mode |
| DDC_DAT_OUT | 10 | DDC data connector side |
| DDC_CLK_OUT | 11 | DDC clock connector side |
| CEC_OUT | 12 | CEC connector side |
| GND | Pad | ground |

HDMI ESD protection, level shifter and backdrive protection

7. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|---|-----|-----------|------|------|
| V_{ESD} | electrostatic discharge | signal pins to ground | | | | |
| | voltage | at HDMI/DVI connector side | [1] | - | ±10 | kV |
| | | all pins | [2] | - | ±200 | V |
| | | all pins | [3] | - | ±2 | kV |
| V _{CC} | supply voltage | | | GND - 0.5 | 5.5 | V |
| VI | input voltage | | | GND - 0.5 | 5.5 | V |
| P _{tot} | total power dissipation | ACTIVE = HIGH; DDC operating at 100 kHz, 50 % duty cycle; CEC operating at 1 kHz, 50 % duty cycle | [4] | - | 30 | mW |
| | | disable: HDMI cable not connected; ACTIVE = LOW, DDC bus in Idle mode | | - | 0.2 | mW |
| T _{stg} | storage temperature | | | -55 | +125 | °C |
| T _{amb} | ambient temperature | | | -40 | +85 | °C |

^[1] IEC 61000-4-2, level 4, contact discharge.

8. Characteristics

Table 4. Supplies

GND = 0 V; T_{amb} = 25 °C; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|------------------------|------------|------|-----|------|------|
| V _{CC(5V0)} | supply voltage (5.0 V) | | 4.5 | 5.0 | 5.5 | V |
| V _{CC(1V8)} | supply voltage (1.8 V) | | 1.62 | 1.8 | 3.63 | V |

Table 5. Static characteristics

 $V_{CC(5V0)} = 5.0 \text{ V}; V_{CC(1V8)} = 1.8 \text{ V}; GND = 0 \text{ V}; T_{amb} = 25 \text{ °C}; unless otherwise specified.}$

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------------|---|--|-----|-----|-----|-----|------|
| HDMI_5V0_ | OUT | | | | | | |
| R_{dyn} | dynamic resistance | | [1] | | | | |
| | | positive transient | | - | 0.6 | - | Ω |
| | | negative transient | | - | 0.4 | - | Ω |
| V _{CL(ch)trt(pos)} | positive transient channel clamping voltage | $V_{ESD} = 8 \text{ kV}, t_p = 100 \text{ ns}$ | [2] | - | 8.0 | - | V |
| ACTIVE | | | | | | | |
| V _{IH} | HIGH-level input voltage | | [3] | 1.2 | - | - | V |
| V_{IL} | LOW-level input voltage | | | - | - | 0.8 | V |
| R _{pd} | pull-down resistance | | | 60 | 100 | 140 | kΩ |

IP4791CZ12

All information provided in this document is subject to legal disclaimers.

^[2] Machine Model (MM) according to JESD22-A115-A.

^[3] Human Body Model (HBM) according to JESD22-A-J114D.

^[4] Including the current through the internal pull-up resistors.

HDMI ESD protection, level shifter and backdrive protection

 Table 5.
 Static characteristics ...continued

 $V_{CC(5V0)} = 5.0 \text{ V}; V_{CC(1V8)} = 1.8 \text{ V}; \text{GND} = 0 \text{ V}; T_{amb} = 25 \text{ }^{\circ}\text{C}; \text{unless otherwise specified.}$

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|------------------------------|--|------------|---------------------------|------|---------------------------|------|
| DDC buffe | r - connector side (pin 10 a | nd pin 11) [<u>3]</u> | | | | | |
| V_{IH} | HIGH-level input voltage | | | $0.5 \times V_{CC(5V0)}$ | - | 5.5 | V |
| V_{IL} | LOW-level input voltage | | | -0.5 | - | $0.3 \times V_{CC(5V0)}$ | V |
| V _{IK} | input clamping voltage | $I_I = -18 \text{ mA}$ | | - | -1.0 | - | V |
| V_{OL} | LOW-level output voltage | internal pull-down current | | - | 100 | 200 | mV |
| V_{OH} | HIGH-level output voltage | | [4] | $V_{CC(5V0)} - 0.02$ | - | $V_{CC(5V0)} + 0.02$ | V |
| C _{IO} | input/output capacitance | $\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(1V8)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$ | [4] | - | 8 | 10 | pF |
| R _{pu} | pull-up resistance | | | 1.6 | 1.8 | 2.0 | kΩ |
| DDC buffe | r - system side (pin 2 and p | in 3) [<u>3]</u> | | | | | |
| V _{IH} | HIGH-level input voltage | | | $0.26 \times V_{CC(1V8)}$ | - | - | V |
| V_{IL} | LOW-level input voltage | | | - | - | $0.20 \times V_{CC(1V8)}$ | V |
| V_{IK} | input clamping voltage | $I_I = -18 \text{ mA}$ | | - | -1.0 | - | V |
| V_{OL} | LOW-level output voltage | | | - | - | $0.28 \times V_{CC(1V8)}$ | V |
| V_{OH} | HIGH-level output voltage | | <u>[4]</u> | $V_{CC(1V8)} - 0.02 \\$ | - | $V_{CC(1V8)} + 0.02$ | V |
| C _{IO} | input/output capacitance | $\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(1V8)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$ | <u>[4]</u> | - | 6 | 8 | pF |
| R _{pu} | pull-up resistance | | | 3.2 | 3.65 | 4.1 | kΩ |
| CEC_OUT | [3] | | | | | | |
| V _{IH} | HIGH-level input voltage | | | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | | | - | - | 0.80 | V |
| V _{OH} | HIGH-level output voltage | | | 2.88 | 3.3 | 3.63 | V |
| V_{OL} | LOW-level output voltage | $I_{OL} = 1.5 \text{ mA}$ | | - | 100 | 200 | mV |
| C _{IO} | input/output capacitance | $\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(1V8)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$ | [4] | - | 8 | 10 | pF |
| R _{pu} | pull-up resistance | | | 23.4 | 26.0 | 28.6 | kΩ |

HDMI ESD protection, level shifter and backdrive protection

 Table 5.
 Static characteristics ...continued

 $V_{CC(5V0)} = 5.0 \text{ V}; V_{CC(1V8)} = 1.8 \text{ V}; \text{GND} = 0 \text{ V}; T_{amb} = 25 \text{ °C}; \text{ unless otherwise specified.}$

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|---------------------------|--|-----|---------------------------|------|---------------------------|-----------|
| CEC_IN 3 | | | | | | | |
| V_{IH} | HIGH-level input voltage | | | $0.26 \times V_{CC(1V8)}$ | - | - | V |
| V_{IL} | LOW-level input voltage | | | - | - | $0.20 \times V_{CC(1V8)}$ | V |
| V_{OH} | HIGH-level output voltage | | [4] | $V_{CC(1V8)} - 0.02$ | - | $V_{CC(1V8)} + 0.02$ | V |
| V_{OL} | LOW-level output voltage | | | - | - | $0.28 \times V_{CC(1V8)}$ | V |
| C _{IO} | input/output capacitance | $\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(1V8)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$ | [4] | - | 6 | 7 | pF |
| R_{pu} | pull-up resistance | | | 8.5 | 10.0 | 11.5 | $k\Omega$ |
| HOTPLUG_ | DET_IN [3] | | | | | | |
| V_{IH} | HIGH-level input voltage | | | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | | | - | - | 0.8 | V |
| R _{pd} | pull-down resistance | | | 60 | 100 | 140 | $k\Omega$ |
| C _i | input capacitance | $\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(1V8)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$ | [4] | - | 8 | 10 | pF |
| HOTPLUG_ | DET_OUT 🗵 | | | | | | |
| V_{OH} | HIGH-level output voltage | $I_{OL} = 1 \text{ mA}$ | | $0.7 \times V_{CC(1V8)}$ | - | - | ٧ |
| V_{OL} | LOW-level output voltage | $I_{OL} = -1 \text{ mA}$ | | - | 200 | 300 | mV |
| R _{pd} | pull-down resistance | | | 60 | 100 | 140 | kΩ |

^[1] ANSI-ESDSP5.5.1-2004, ESD sensitivity testing TLP component level method 50 TDR.

Table 6. Dynamic characteristics

 $V_{CC(5V0)} = 5.0$ V; $V_{CC(1V8)} = 1.8$ V; GND = 0 V; $T_{amb} = 25$ °C; unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|------------------|-------------------------------|---|-----|-----|-----|-----|------|
| DDC_DAT_ | IN, DDC_CLK_IN, DDC_DAT_OUT | , DDC_CLK_OUT | | | | | |
| t _{PLH} | LOW to HIGH propagation delay | system side to connector side Figure 3 | [1] | - | 80 | - | ns |
| t _{PHL} | HIGH to LOW propagation delay | system side to connector side Figure 3 | [1] | - | 60 | - | ns |
| t _{PLH} | LOW to HIGH propagation delay | connector side to system side $\underline{\text{Figure 4}}$ | [1] | - | 120 | - | ns |
| t _{PHL} | HIGH to LOW propagation delay | connector side to system side Figure 4 | [1] | - | 80 | - | ns |
| t _{TLH} | LOW to HIGH transition time | connector side Figure 5 | [1] | - | 150 | - | ns |
| t _{THL} | HIGH to LOW transition time | connector side Figure 5 | [1] | - | 100 | - | ns |
| t _{TLH} | LOW to HIGH transition time | system side Figure 6 | [1] | - | 250 | - | ns |
| t _{THL} | HIGH to LOW transition time | system side Figure 6 | [1] | - | 80 | - | ns |

^[1] All dynamic measurements are done with a 50 pF load. Rise times are determined by internal pull-up resistors.

IP4791CZ12 All information provided in this document is subject to legal disclaimers.

^[2] According to IEC 61000, level 4, contact discharge.

^[3] The device is active if the input voltage at pin ACTIVE is above the HIGH level.

^[4] This parameter is guaranteed by design.

HDMI ESD protection, level shifter and backdrive protection

9. AC waveforms

9.1 DDC propagation delay

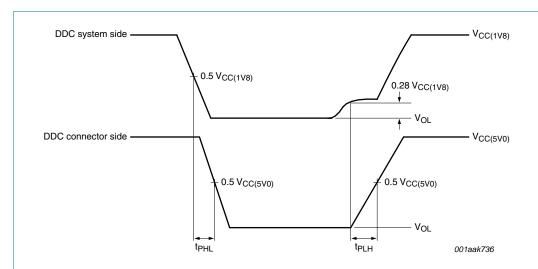


Fig 3. Propagation delay DDC, DDC system side to DDC connector side

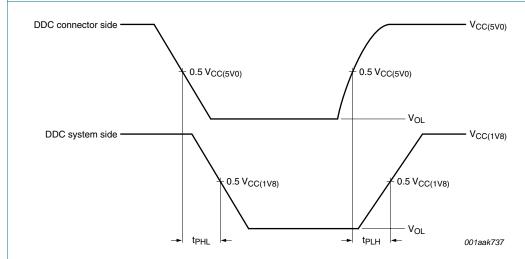


Fig 4. Propagation delay DDC, DDC connector side to DDC system side

HDMI ESD protection, level shifter and backdrive protection

9.2 DDC transition time

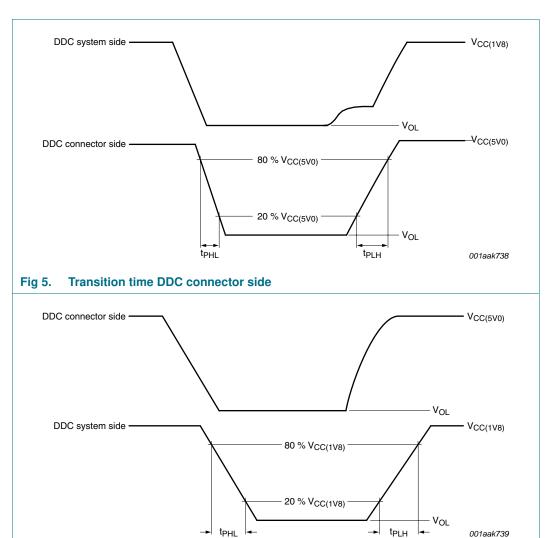


Fig 6. Transition time DDC system side

HDMI ESD protection, level shifter and backdrive protection

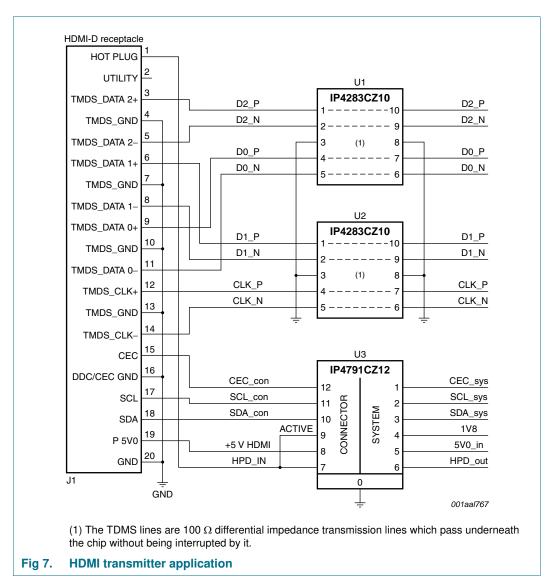
10. Application information

10.1 HDMI source

The IP4791CZ12 simplifies the application of a mobile HDMI source.

No external components are needed for the application to adapt the HDMI port to the HDMI transmitter.

Note: The 5 V supply voltage must be in the range 4.8 V to 5.3 V to pass the HDMI compliance test.



The ACTIVE pin is enabling the IP4791CZ12 with a voltage above 1.2 V. Connecting the ACTIVE pin to the HOT PLUG line will enable the IP4791CZ12 automatically if any HDMI sink is connected to the HDMI port and disable (switch to power-saving mode of the IP4791CZ12) when no HDMI sink is connecting to the HDMI port.

HDMI ESD protection, level shifter and backdrive protection

11. Package outline

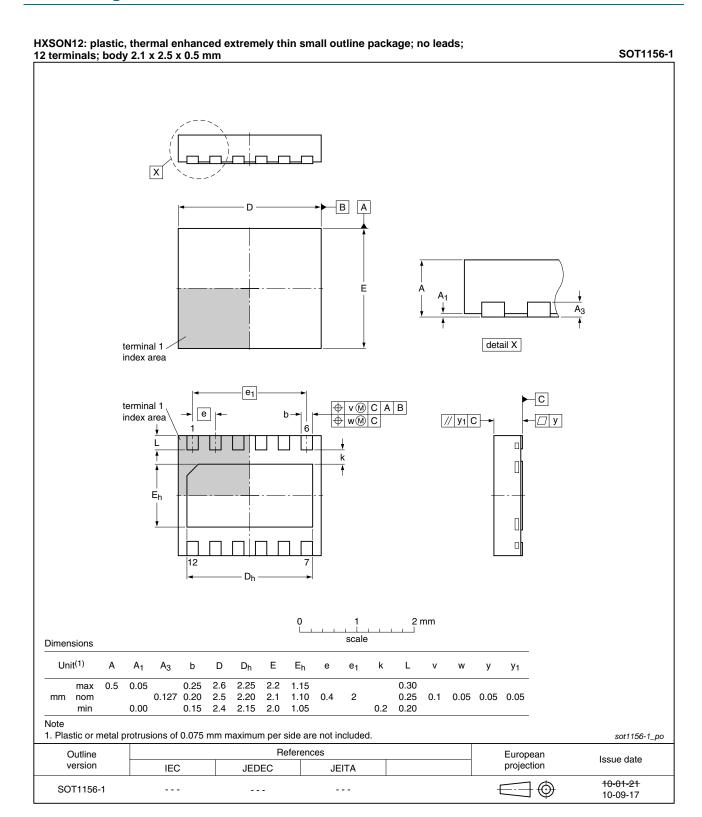


Fig 8. Package outline SOT1156-1 (HXSON12)

IP4791CZ12 All information provided in this document is subject to legal disclaimers.

© Nexperia B.V. 2017. All rights reserved

HDMI ESD protection, level shifter and backdrive protection

12. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

12.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

12.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- · Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- · Package placement
- · Inspection and repair
- · Lead-free soldering versus SnPb soldering

12.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

IP4791CZ12

HDMI ESD protection, level shifter and backdrive protection

12.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 9</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 7 and 8

Table 7. SnPb eutectic process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) | | | | |
|------------------------|---------------------------------|-------|--|--|--|
| | Volume (mm ³) | | | | |
| | < 350 | ≥ 350 | | | |
| < 2.5 | 235 | 220 | | | |
| ≥ 2.5 | 220 | 220 | | | |

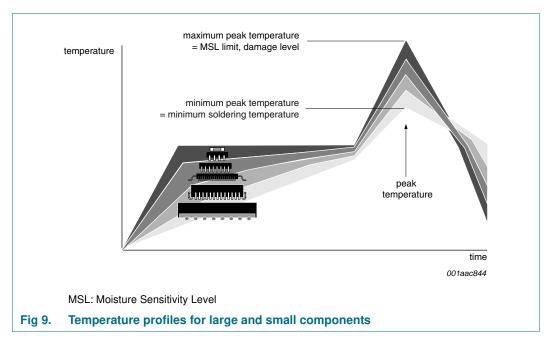
Table 8. Lead-free process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) | | | | |
|------------------------|---------------------------------|-------------|--------|--|--|
| | Volume (mm ³) | | | | |
| | < 350 | 350 to 2000 | > 2000 | | |
| < 1.6 | 260 | 260 | 260 | | |
| 1.6 to 2.5 | 260 | 250 | 245 | | |
| > 2.5 | 250 | 245 | 245 | | |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 9.

HDMI ESD protection, level shifter and backdrive protection



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

13. Abbreviations

Table 9. Abbreviations

| Description |
|--|
| Consumer Electronic Control |
| Data Display Channel |
| Digital Visual Interface |
| ElectroStatic Discharge |
| High-Definition Multimedia Interface |
| Restriction of Hazardous Substances |
| Transition Minimized Differential Signalling |
| Time Domain Reflectometer |
| Transmission Line Pulse |
| |

HDMI ESD protection, level shifter and backdrive protection

14. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|----------------|--|--|---------------|----------------|--|--|
| IP4791CZ12 v.3 | 20110107 | Product data sheet | - | IP4791CZ12 v.2 | | |
| Modifications: | <u>Table 3 "Limiting values"</u> : P _{tot} maximum value updated. | | | | | |
| | • Table 5 "Sta | tic characteristics": V _{IK} upda | ted. | | | |
| | Section 10.1 | I "HDMI source": enhanced. | | | | |
| IP4791CZ12 v.2 | 20101111 | Preliminary data sheet | - | IP4791CZ12 v.1 | | |
| IP4791CZ12 v.1 | 20100401 | Objective data sheet | - | - | | |

HDMI ESD protection, level shifter and backdrive protection

15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

IP4791CZ12

All information provided in this document is subject to legal disclaimers.

HDMI ESD protection, level shifter and backdrive protection

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nexperia.com

For sales office addresses, please send an email to: salesaddresses@nexperia.com

IP4791CZ12

HDMI ESD protection, level shifter and backdrive protection

17. Contents

Nexperia

| 1 | General description 1 |
|------|------------------------------|
| 2 | Features and benefits |
| 3 | Applications |
| 4 | Ordering information 2 |
| 5 | Functional diagram 2 |
| 6 | Pinning information 3 |
| 6.1 | Pinning |
| 6.2 | Pin description |
| 7 | Limiting values 4 |
| 8 | Characteristics 4 |
| 9 | AC waveforms |
| 9.1 | DDC propagation delay 7 |
| 9.2 | DDC transition time 8 |
| 10 | Application information 9 |
| 10.1 | HDMI source 9 |
| 11 | Package outline |
| 12 | Soldering of SMD packages 11 |
| 12.1 | Introduction to soldering |
| 12.2 | Wave and reflow soldering 11 |
| 12.3 | Wave soldering |
| 12.4 | Reflow soldering |
| 13 | Abbreviations13 |
| 14 | Revision history 14 |
| 15 | Legal information 15 |
| 15.1 | Data sheet status |
| 15.2 | Definitions |
| 15.3 | Disclaimers |
| 15.4 | Trademarks |
| 16 | Contact information 16 |
| 17 | Contents |